

MOS FIELD EFFECT TRANSISTOR μ PA1756

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is Dual N-Channel MOS Field Effect Transistor designed for power management application of notebook computers, and Li-ion battery application.

FEATURES

- Dual MOS FET chips in small package
- 2.5-V gate drive type and low on-resistance $R_{DS(on)1} = 30 \text{ m}\Omega \text{ MAX}. (V_{GS} = 4.5 \text{ V}, I_D = 3.0 \text{ A})$ $R_{DS(on)2} = 40 \text{ m}\Omega \text{ MAX}. (V_{GS} = 2.5 \text{ V}, I_D = 3.0 \text{ A})$
- Low Ciss Ciss = 800 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1756G	Power SOP8

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (Vgs = 0 V)	Vdss	20	V	EQUIVALENT CIRCUIT
Gate to Source Voltage ($V_{DS} = 0 V$)	Vgss	±12.0	V	Duraha
Drain Current (DC)	D(DC)	±6.0	А	Drain ho
Drain Current (Pulse) ^{Note1}	D(pulse)	±24	А	Body
Total Power Dissipation (1 unit) ^{Note2}	Pτ	1.7	W	Gate Diode
Total Power Dissipation (2 unit) ^{Note2}	P⊤	2.0	W	
Channel Temperature	Tch	150	°C	Gate
Storage Temperature	Tstg	-55 to +150	°C	Diode

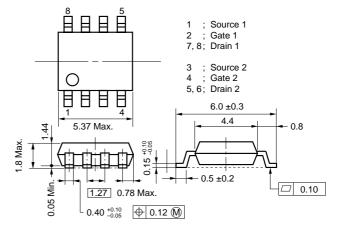
Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. TA = 25 °C, Mounted on ceramic substrate of 2000 mm² x 1.1 mm

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Document No. D12909EJ1V0DS00 (1st edition) Date Published February 1999 NS CP (K) Printed in Japan PACKAGE DRAWING (Unit : mm)

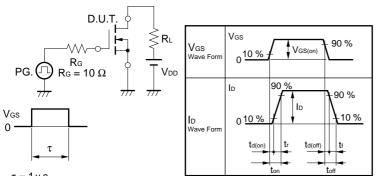


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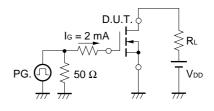
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 4.5 V, Id = 3.0 A		20.0	30	mΩ
	RDS(on)2	Vgs = 2.5 V, Id = 3.0 A		25.8	40	mΩ
Gate to Source Cut-off Voltage	VGS(off)	V _{DS} = 10 V, I _D = 1.0 mA	0.5	0.7	1.5	V
Forward Transfer Admittance	yfs	Vds = 10 V, Id = 3.0 A	4.0	12		S
Drain Leakage Current	IDSS	Vds = 20 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 12.0 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V _{DS} = 10 V		800		pF
Output Capacitance	Coss	V _G s = 0 V		360		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		70		pF
Turn-on Delay Time	td(on)	ID = 3.0A		110		ns
Rise Time	tr	$V_{GS(on)} = 4.0 V$		425		ns
Turn-off Delay Time	td(off)	Vdd = 10 V		1050		ns
Fall Time	tr	R _G = 10 Ω		1200		ns
Total Gate Charge	QG	ID = 6.0 A		11		nC
Gate to Source Charge	QGS	Vdd = 16 V		2.0		nC
Gate to Drain Charge	Qgd	Vgs = 4.0 V		4.6		nC
Body Diode Forward Voltage	VF(S-D)	IF = 6.0 A, VGS = 0 V		0.8		V

TEST CIRCUIT 1 SWITCHING TIME

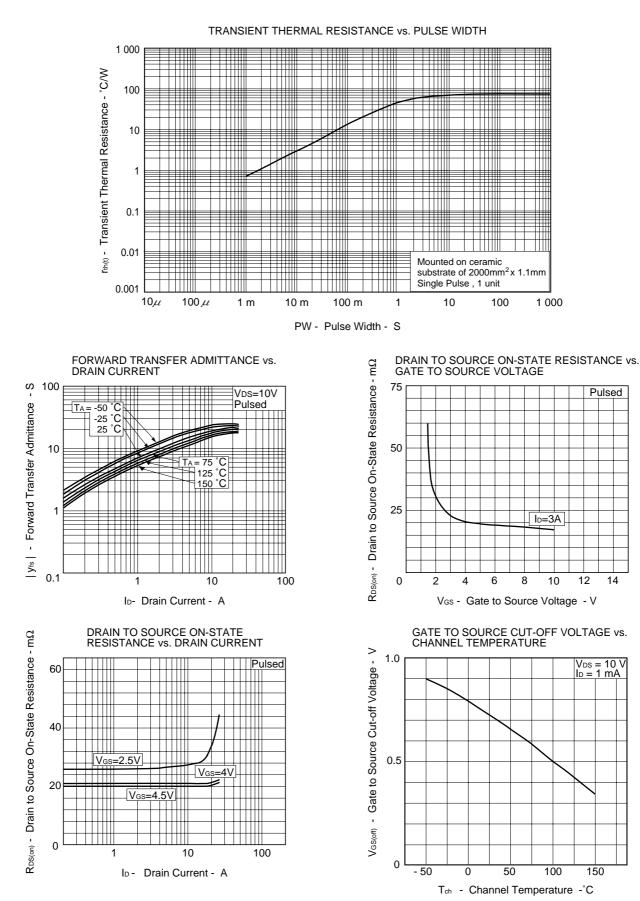


TEST CIRCUIT 2 GATE CHARGE



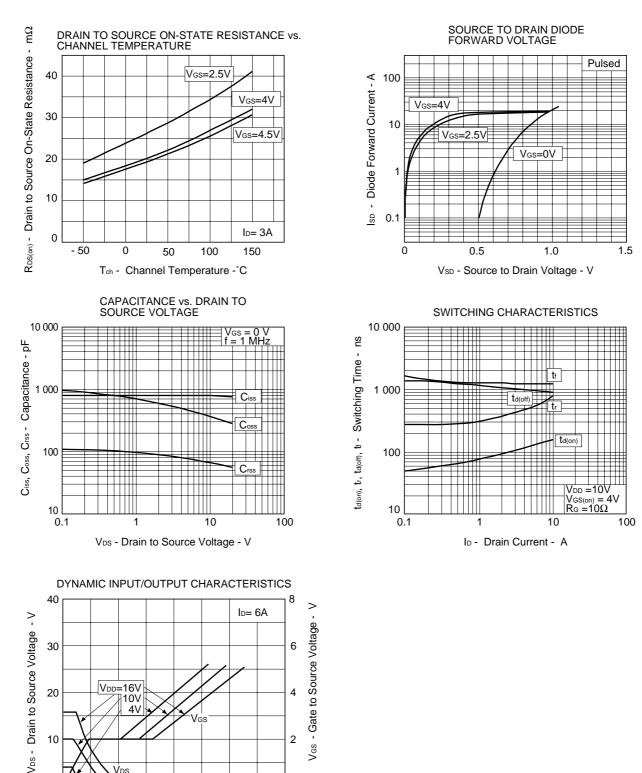
 $\tau = 1 \mu s$ Duty Cycle $\leq 1 \%$

TYPICAL CHARACTERISTICS (TA = 25 °C)



Data Sheet D12909EJ1V0DS00

NEC



Data Sheet D12909EJ1V0DS00

___0 16

Vos

4

8

QG - Gate Charge - nC

12

0

75°C

0.1

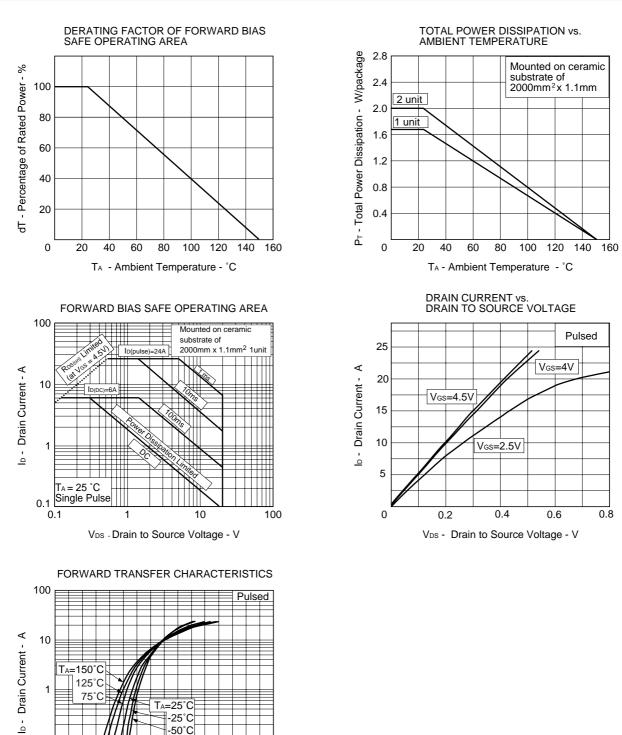
0

T_A=25°C -25°C -50°C

VGS - Gate to Source Voltage - V

VDS=10V

3



[MEMO]

[MEMO]

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